

Global Wafer Backgrinding Tape and Dicing Tapes Market Research Report 2026(Status and Outlook)

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Abstracts

This report studies the semiconductor wafer tape, include UV tapes and Non-UV tapes used in wafer Back Grinding and wafer dicing process. UV tape has stronger adhesive strength and can hold wafer firmly in back grinding process or dicing process. After UV irradiation, adhesive strength decreases drastically and easy de-taping or die pick up can be achieved. Non-UV tape, which is designed to peel-off from wafer material without UV irradiation. Back Grinding Tape is a type of adhesive tape used for grinding the back of silicon wafers, also known as back grinding tape. It is usually made of polyimide film, with high strength and high temperature resistance. In the semiconductor manufacturing process, silicon wafers need to undergo back grinding to reduce their thickness, in order to achieve higher integration in subsequent steps. The Back Grinding Tape secures the silicon wafer on the back grinder and protects the surface of the wafer from damage during the grinding process. The selection of Back Grinding Tape depends on the size and shape of the silicon wafer, as well as the type of abrasive used during the grinding process and the parameters of the grinding machine. Usually, manufacturers provide different types and specifications of Back Grinding Tapes to meet different application requirements. In terms of consumption side, China Taiwan is currently the world's largest consumer market, accounting for 34.0% of the market share in 2023, followed by mainland China and North America, accounting for 27.4% and 9.27% respectively. Southeast Asia is expected to grow fastest in the next few years, with a CAGR of approximately 10.6% during 2024-2030. From the production side, Japan is the largest production area, and the key manufacturers are mainly headquartered in Japan. In 2023, Japan accounted for approximately 83% of the production share. It is expected that in the next few years, the production of wafer tape in the Chinese market will maintain the fastest growth rate, and the share is expected to reach 9.41% in 2030. In terms of product type, UV wafer tape has a higher proportion, with a share of 62.5% in 2023 and an estimated share of 64% in 2030. From the application point of view, the

wafer cutting process accounts for a high proportion, with a share of 54.95% in 2023. It is expected that the wafer grinding process will grow faster in the next few years, and the share will increase from 45.05% in 2023 to 46.01% in 2030. From the perspective of manufacturers, the key manufacturers of semiconductor wafer tapes worldwide mainly include Mitsui Chemicals, LINTEC Corporation, Furukawa Electric, Denka, Nitto Denko Corporation, Maxell Siontec and Sekisui Chemical. In 2023, the top five manufacturers in the world accounted for about 82.5% of the market share. Chinese local manufacturers of wafer tapes are currently mainly in the verification and small batch stages. Representative companies include Shanghai Guke Adhesive Tape Technology, Plusco Tech, Taicang Zhanxin Adhesive Material, Cybrid Technologies, ZZSM, BYE POLYMER MATERIAL, ZHONGSHAN CROWN ADHESIVE PRODUCTS, Yantai Darbond Technology and Sunliky New Material Technology. It is expected that in the next few years, Chinese local companies will gradually grow and occupy a higher share in the Chinese market.

The global Wafer Backgrinding Tape and Dicing Tapes market size was estimated at USD 808.0 million in 2025 and is projected to grow at a compound annual growth rate (CAGR) of 8.90% during the forecast period.

This report offers a comprehensive and in-depth analysis of the global Wafer Backgrinding Tape and Dicing Tapes market, covering all critical facets from a broad macroeconomic overview to detailed micro-level insights. It examines market size, competitive landscape, emerging development trends, niche segments, key drivers and challenges, as well as conducts SWOT and value chain analyses.

The insights provided enable readers to understand the competitive dynamics within the industry and formulate effective strategies to enhance profitability and market positioning. Additionally, the report presents a clear framework for evaluating the current status and future outlook of business organizations operating in this sector.

A significant focus of this report lies in the competitive landscape of the global Wafer Backgrinding Tape and Dicing Tapes market. It offers detailed profiles of major players, including their market shares, performance metrics, product portfolios, and operational status. This enables stakeholders to identify leading competitors and gain a nuanced understanding of market rivalry and structure.

In summary, this report serves as an essential resource for industry participants, investors, researchers, consultants, and business strategists, as well as anyone planning to enter or expand their presence in the Wafer Backgrinding Tape and Dicing

Tapes market.

Global Wafer Backgrinding Tape and Dicing Tapes Market: Market Segmentation Analysis

This research report provides a detailed segmentation of the market by region (country), key manufacturers, product type, and application. Market segmentation divides the overall market into distinct subsets based on factors such as product categories, end-user industries, geographic locations, and other relevant criteria.

A clear understanding of these market segments enables decision-makers to tailor their product development, sales, and marketing strategies more effectively to meet the unique needs of each segment. Leveraging market segmentation insights can significantly enhance targeted approaches, optimize resource allocation, and accelerate product innovation cycles by aligning offerings with the specific demands of diverse customer groups.

Key Company

Mitsui Chemicals
LINTEC Corporation
Denka
Nitto Denko Corporation
Furukawa Electric
Sekisui Chemical
Maxell Siontec
Resonac Corporation
Sumitomo Bakelite Company
D&X Co., Ltd
KGK Chemical Corporation
AI Technology, Inc. (AIT)
Ultron System
Daehyun ST
Solar Plus Company
Alliance Material Co., Ltd (AMC)
3M
Shanghai Guke Adhesive Tape Technology
Plusco Tech
Taicang Zhanxin Adhesive Material

Cybrid Technologies
ZZSM
BYE POLYMER MATERIAL
ZHONGSHAN CROWN ADHESIVE PRODUCTS
Yantai Darbond Technology
Sunliky New Material Technology
GTA Material

Market Segmentation (by Type)

UV Tape
Non-UV Tape

Market Segmentation (by Application)

Back Grinding Tape
Dicing Tape

Geographic Segmentation

North America (USA, Canada, Mexico)
Europe (Germany, UK, France, Russia, Italy, Rest of Europe)
Asia-Pacific (China, Japan, South Korea, India, Southeast Asia, Rest of Asia-Pacific)
South America (Brazil, Argentina, Columbia, Rest of South America)
The Middle East and Africa (Saudi Arabia, UAE, Egypt, Nigeria, South Africa, Rest of MEA)

Key Benefits of This Market Research:

Industry drivers, restraints, and opportunities covered in the study
Neutral perspective on the market performance
Recent industry trends and developments
Competitive landscape & strategies of key players
Potential & niche segments and regions exhibiting promising growth covered
Historical, current, and projected market size, in terms of value
In-depth analysis of the Wafer Backgrinding Tape and Dicing Tapes Market
Overview of the regional outlook of the Wafer Backgrinding Tape and Dicing Tapes Market:

Customization of the Report

In case of any queries or customization requirements, please connect with our sales team, who will ensure that your requirements are met.

Chapter Outline

Chapter 1 mainly introduces the statistical scope of the report, market division standards, and market research methods.

Chapter 2 is an executive summary of different market segments (by region, product type, application, etc), including the market size of each market segment, future development potential, and so on. It offers a high-level view of the current state of the Wafer Backgrinding Tape and Dicing Tapes Market and its likely evolution in the short to mid-term, and long term.

Chapter 3 makes a detailed analysis of the market's competitive landscape of the market and provides the market share, capacity, output, price, latest development plan, merger, and acquisition information of the main manufacturers in the market.

Chapter 4 is the analysis of the whole market industrial chain, including the upstream and downstream of the industry, as well as Porter's five forces analysis.

Chapter 5 introduces the latest developments of the market, the driving factors and restrictive factors of the market, the challenges and risks faced by manufacturers in the industry, and the analysis of relevant policies in the industry.

Chapter 6 provides the analysis of various market segments according to product types, covering the market size and development potential of each market segment, to help readers find the blue ocean market in different market segments.

Chapter 7 provides the analysis of various market segments according to application, covering the market size and development potential of each market segment, to help readers find the blue ocean market in different downstream markets.

Chapter 8 provides a quantitative analysis of the market size and development potential of each region and its main countries and introduces the market development, future development prospects, market space, and capacity of each country in the world.

Chapter 9 shares the main producing countries of Wafer Backgrinding Tape and Dicing Tapes, their output value, profit level, regional supply, production capacity layout, etc. from the supply side.

Chapter 10 introduces the basic situation of the main companies in the market in detail, including product sales revenue, sales volume, price, gross profit margin, market share, product introduction, recent development, etc.

Chapter 11 provides a quantitative analysis of the market size and development potential of each region in the next five years.

Chapter 12 provides a quantitative analysis of the market size and development potential of each market segment in the next five years.

Chapter 13 is the main points and conclusions of the report.

Key Reasons to Buy this Report:

Access to date statistics compiled by our researchers. These provide you with historical and forecast data, which is analyzed to tell you why your market is set to change

This enables you to anticipate market changes to remain ahead of your competitors

You will be able to copy data from the Excel spreadsheet straight into your marketing plans, business presentations, or other strategic documents

The concise analysis, clear graph, and table format will enable you to pinpoint the information you require quickly

Provision of market value data for each segment and sub-segment

Indicates the region and segment that is expected to witness the fastest growth as well as to dominate the market

Analysis by geography highlighting the consumption of the product/service in the region as well as indicating the factors that are affecting the market within each region

Competitive landscape which incorporates the market ranking of the major players, along with new service/product launches, partnerships, business expansions, and acquisitions in the past five years of companies profiled

Extensive company profiles comprising of company overview, company insights, product benchmarking, and SWOT analysis for the major market players

The current as well as the future market outlook of the industry concerning recent developments which involve growth opportunities and drivers as well as challenges and restraints of both emerging as well as developed regions

Includes in-depth analysis of the market from various perspectives through Porter's five

forces analysis

Provides insight into the market through Value Chain

Market dynamics scenario, along with growth opportunities of the market in the years to come

6-month post-sales analyst support

Customization of the Report

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